

Form PTO-1595 (Rev. 09/04)
OMB No. 0651-0027 (exp. 8/30/2005)

U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office

RECORDATION FORM COVER SHEET PATENTS ONLY


To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

<p>1. Name of conveying party(ies)/Execution Date(s): YOUSUKE KIMOTO (07/11/2002) AND KAZUHIRO KANEE (07/11/2002)</p> <p>Execution Date(s): In parentheses after inventor name</p> <p>Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>	<p>2. Name and address of receiving party(ies)</p> <p style="text-align: center;">SONY COMPUTER ENTERTAINMENT INC.</p> <p>Name: _____</p> <p>Internal Address: _____</p> <p>Street Address: _____</p> <p>1-7-1 Konan, Minato-ku Tokyo 108-0075 JAPAN</p> <p>City: _____</p> <p>State: _____</p> <p>Country: _____ Zip: _____</p> <p>Additional name(s) & address(es) attached: <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>
<p>3. Nature of Conveyance:</p> <p><input type="checkbox"/> Assignment <input type="checkbox"/> Merger</p> <p><input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name</p> <p><input type="checkbox"/> Government Interest Assignment</p> <p><input type="checkbox"/> Executive Order 9424, Confirmatory License</p> <p><input checked="" type="checkbox"/> Other Correction to Reel 026685, Frame 0799 to correct spelling of inventor Yousuke Kimoto's name.</p>	

<p>4. Application or patent number(s):</p> <p>A. Patent Application No.(s) 12/456,452</p>	<p><input type="checkbox"/> This document is being filed together with a new application.</p> <p>B. Patent No.(s)</p> <p>Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>
--	---

<p>5. Name and address to whom correspondence concerning document should be mailed:</p> <p>Name: Daryl K. Neff LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP</p> <p>Internal Address: Atty. Dkt.: SCEI 3.0-132 CON</p> <p>Street Address: 600 South Avenue West</p> <p>City: Westfield</p> <p>State: NJ Zip: 07090</p> <p>Phone Number: (908) 518-6396</p> <p>Fax Number: (908) 654-0415</p> <p>Email Address: dneff@ldlkm.com</p>	<p>6. Total number of applications and patents involved: <input type="text" value="1"/></p> <p>7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00</p> <p><input type="checkbox"/> Authorized to be charged by credit card</p> <p><input checked="" type="checkbox"/> Authorized to be charged to deposit account</p> <p><input type="checkbox"/> Enclosed</p> <p><input type="checkbox"/> None required (government interest not affecting title)</p> <p>8. Payment Information</p> <p>a. Credit Card Last 4 Numbers _____ Expiration Date _____</p> <p>b. Deposit Account Number 12-1095 Authorized User Name Daryl K. Neff</p>
--	--

9. Signature:



Signature

March 17, 2011
Date

Daryl K. Neff - 58,253
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

CH \$40.00 121095 12456452

DARYL K. NEFF COMPANY: LERNER, DAVID, LITTENBERG, ET AL

12/14/2010 23:15 FAX 9086547866

LDLKM

+ USPTO ASSIGNMENT 002/004

Form PTO-159d (Rev. 09/14)
OMB No. 0551-0047 (Exp. 03/31/2009)

U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office

REGISTRATION FORM COVER SHEET

ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)/Execution Date(s):

YOSUKE KIMOTO (07/11/2002) AND
KAZUHIRO KANEE (07/11/2002)

Execution Date(s): In parentheses after inventor name

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of Conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other

2. Name and address of receiving party(ies)

SONY COMPUTER
ENTERTAINMENT INC.

Name: _____

Internal Address: _____

Street Address: _____

1-7-1 Konan, Minato-ku
Tokyo
108-0075
JAPAN

City: _____

State: _____

Country: _____ Zip: _____

Additional name(s) & address(es) attached: Yes No

4. Application or patent number(s):

A. Patent Application No.(s)
12/458,452

This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Daryl K. Neff
LERNER, DAVID, LITTENBERG,
KRUMHOLZ & MENTLIK, LLP

Internal Address: Atty. Dkt.: SCEI 3.0-132 CON

Street Address: 800 South Avenue West

City: Westfield

State: NJ Zip: 07090

Phone Number: (908) 518-6388

Fax Number: (908) 654-0415

Email Address: dneff@dlkm.com

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting bill)

8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number 12-1098
Authorized User Name Daryl K. Neff

B. Signature:

December 14, 2010

Date

Daryl K. Neff - 38-253
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

CH 540.00 121095 12456452

DOCUMENT IDENTIFICATION
SCEI Ref. No.: SC02019US00

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

LOG COLLECTING/ANALYZING SYSTEM WITH SEPARATED FUNCTIONS OF COLLECTING LOG INFORMATION AND ANALYZING THE SAME

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Computer Entertainment Inc., a Japanese corporation with offices at 1-1, Akasaka 7-chome, Minato-ku, Tokyo 107-0052, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 10/162,470, Filing Date: June 4, 2002.

This assignment executed on the dates indicated below.

Yousuke Kimoto

Name of First or Sole Inventor

Execution Date of U.S. Patent Application

Kanagawa, Japan

Residence of First or Sole Inventor

Yousuke Kimoto

Signature of First or Sole Inventor

July 11, 2002

Date of this Assignment

PATENT
REEL: 025994 FRAME: 0775

DOCKET NUMBER: SCEI 03-0196
SCEI Ref. No.: SC02019US00

Kazuhiro Kanee

Name of Second Joint Inventor

Execution Date of U.S. Patent Application

Tokyo, Japan
Residence of Second Joint Inventor

Kazuhiro Kanee
Signature of Second Joint Inventor

July 11, 2002
Date of this Assignment

Name of Third Joint Inventor

Execution Date of U.S. Patent Application

Residence of Third Joint Inventor

Signature of Third Joint Inventor

Date of this Assignment

Name of Fourth Joint Inventor

Execution Date of U.S. Patent Application

Residence of Fourth Joint Inventor

Signature of Fourth Joint Inventor

Date of this Assignment

Name of Fifth Joint Inventor

Execution Date of U.S. Patent Application

Residence of Fifth Joint Inventor

Signature of Fifth Joint Inventor

Date of this Assignment

375647_1.DOC